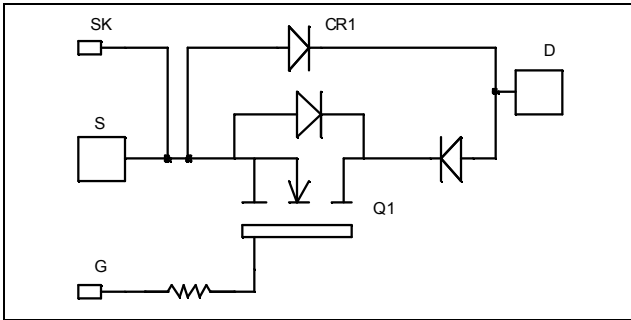


*Single switch  
Series & parallel diodes  
MOSFET Power Module*

**$V_{DSS} = 500V$   
 $R_{DSon} = 25m\Omega$  max @  $T_j = 25^\circ C$   
 $I_D = 149A$  @  $T_c = 25^\circ C$**

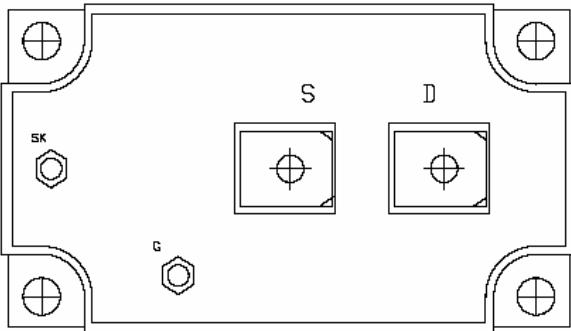


**Application**

- Motor control
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

**Features**

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Low stray inductance
  - M6 power connectors
  - M4 signal connectors
- High level of integration



**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance

**Absolute maximum ratings**

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	500	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	149
		$T_c = 80^\circ C$	110
$I_{DM}$	Pulsed Drain current	550	A
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	25	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	1250
$I_{AR}$	Avalanche current (repetitive and non repetitive)	41	A
$E_{AR}$	Repetitive Avalanche Energy	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy	1600	

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

## Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$BV_{DSS}$	Drain - Source Breakdown Voltage	$V_{GS} = 0V, I_D = 500\mu A$	500			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0V, V_{DS} = 500V$   $T_j = 25^\circ\text{C}$			400	$\mu A$
		$V_{GS} = 0V, V_{DS} = 400V$   $T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain - Source on Resistance	$V_{GS} = 10V, I_D = 74.5A$			25	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 10mA$	3		5	V
$I_{GSS}$	Gate - Source Leakage Current	$V_{GS} = \pm 30V, V_{DS} = 0V$			$\pm 200$	nA

## Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0V$		17.5		nF
$C_{oss}$	Output Capacitance	$V_{DS} = 25V$		3.6		
$C_{rss}$	Reverse Transfer Capacitance	$f = 1MHz$		0.24		
$Q_g$	Total gate Charge	$V_{GS} = 10V$ $V_{Bus} = 250V$ $I_D = 149A$		364		nC
$Q_{gs}$	Gate - Source Charge			96		
$Q_{gd}$	Gate - Drain Charge			196		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive Switching @ <math>125^\circ\text{C}</math></b> $V_{GS} = 15V$ $V_{Bus} = 333V$ $I_D = 149A$ $R_G = 1.2\Omega$		15		ns
$T_r$	Rise Time			21		
$T_{d(off)}$	Turn-off Delay Time			73		
$T_f$	Fall Time			52		

## Series diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle   $T_c = 85^\circ\text{C}$		120		A
$V_F$	Diode Forward Voltage	$I_F = 120A$		1.1	1.15	V
		$I_F = 240A$		1.4		
		$I_F = 120A$   $T_j = 125^\circ\text{C}$		0.9		
$t_{rr}$	Reverse Recovery Time	$I_F = 120A$   $V_R = 133V$   $di/dt = 400A/\mu s$   $T_j = 25^\circ\text{C}$		31		ns
		$T_j = 125^\circ\text{C}$		60		
$Q_{rr}$	Reverse Recovery Charge	$I_F = 120A$   $V_R = 133V$   $di/dt = 400A/\mu s$   $T_j = 25^\circ\text{C}$		120		nC
		$T_j = 125^\circ\text{C}$		500		

## Parallel diode ratings and characteristics

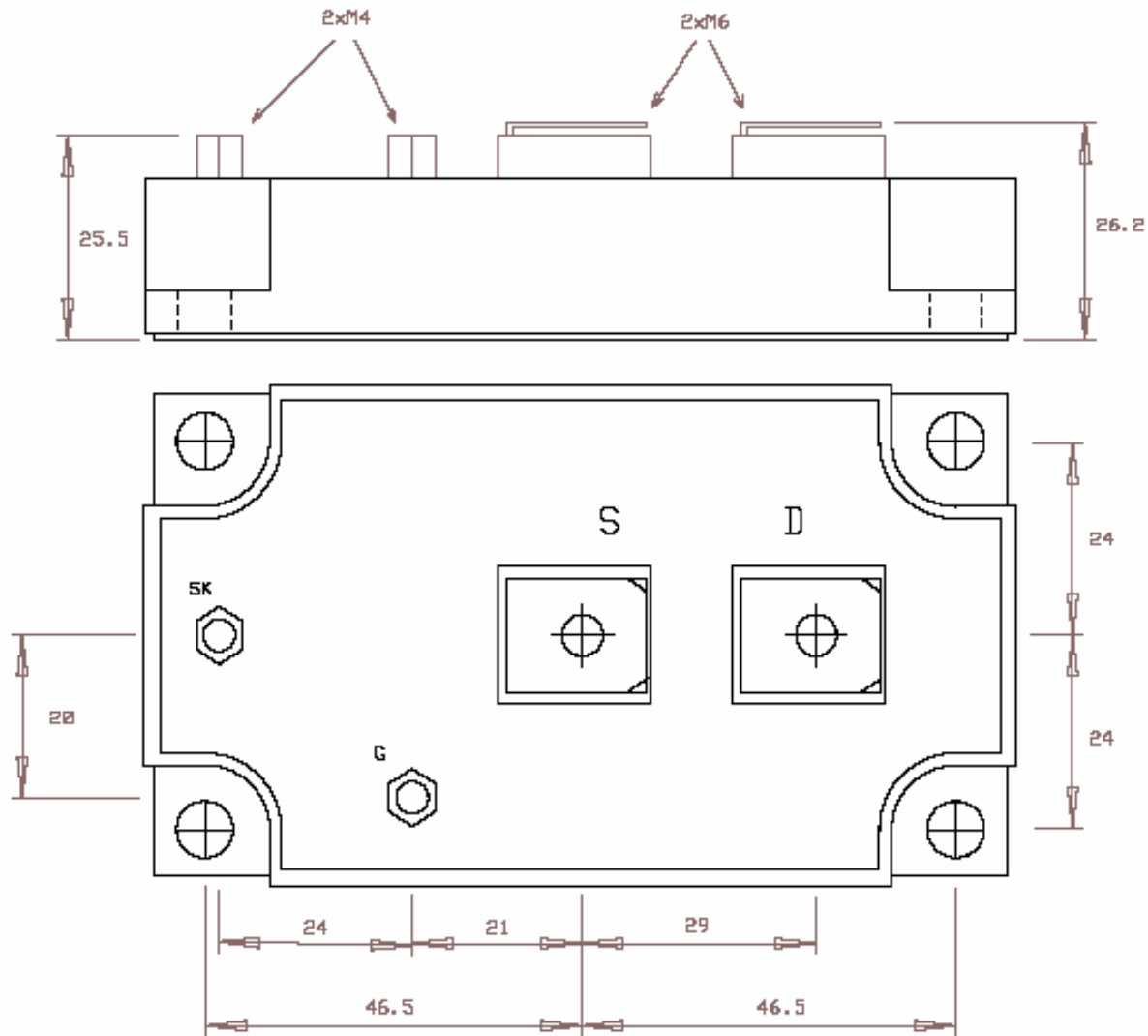
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle   $T_c = 80^\circ\text{C}$		100		A
$V_F$	Diode Forward Voltage	$I_F = 100A$		1.6	1.8	V
		$I_F = 200A$		1.9		
		$I_F = 100A$   $T_j = 125^\circ\text{C}$		1.4		
$t_{rr}$	Reverse Recovery Time	$I_F = 100A$   $V_R = 400V$   $di/dt = 200A/\mu s$   $T_j = 25^\circ\text{C}$		180		ns
		$T_j = 125^\circ\text{C}$		220		
$Q_{rr}$	Reverse Recovery Charge	$I_F = 100A$   $V_R = 400V$   $di/dt = 200A/\mu s$   $T_j = 25^\circ\text{C}$		390		nC
		$T_j = 125^\circ\text{C}$		1450		

**Thermal and package characteristics**

*Symbol Characteristic Min Typ Max Unit*

<i>Symbol</i>	<i>Characteristic</i>	<i>Min</i>	<i>Typ</i>	<i>Max</i>	<i>Unit</i>
R <sub>thJC</sub>	Junction to Case	Transistor		0.1	°C/W
		Series diode		0.46	
		Parallel diode		0.6	
V <sub>ISOL</sub>	RMS Isolation Voltage, any terminal to case t=1 min, I <sub>isol</sub> <1mA, 50/60Hz	2500			V
T <sub>J</sub>	Operating junction temperature range	-40		150	°C
T <sub>STG</sub>	Storage Temperature Range	-40		125	
T <sub>C</sub>	Operating Case Temperature	-40		100	
Torque	Mounting torque	M4		1.2	N.m
		M6	3	5	
Wt	Package Weight			400	g

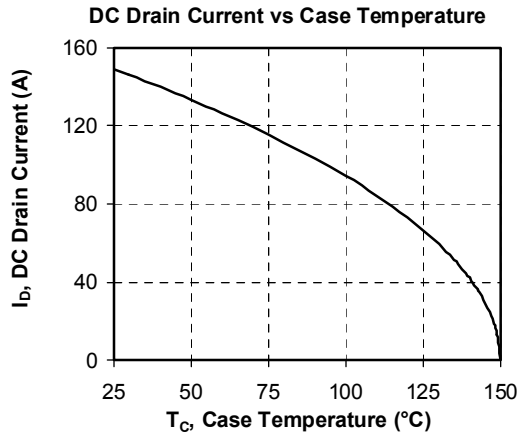
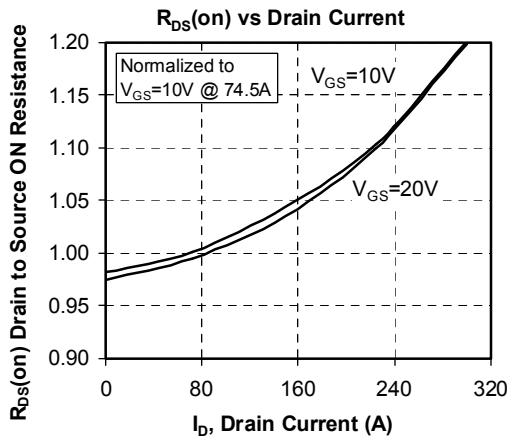
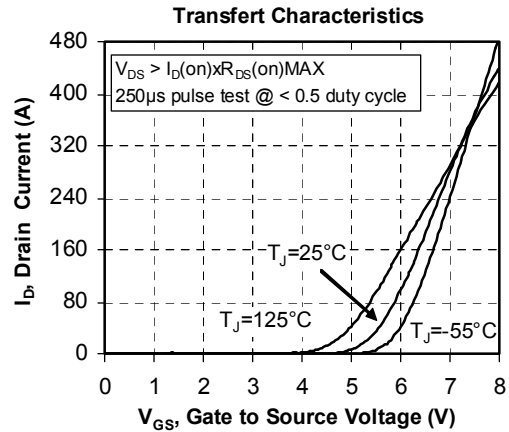
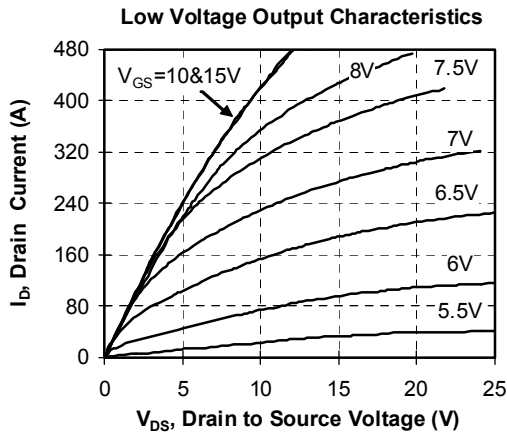
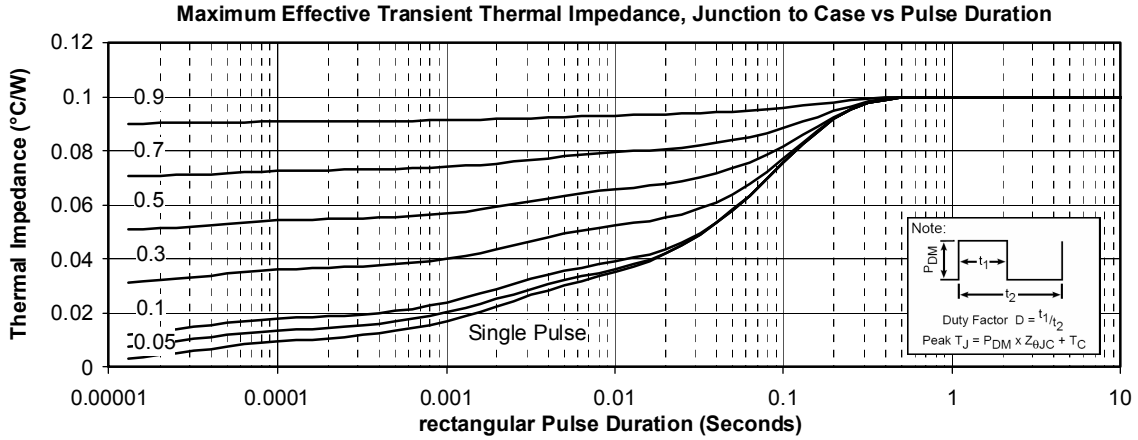
**Package outline**

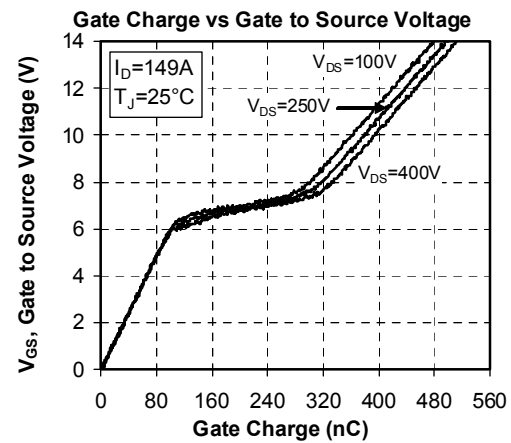
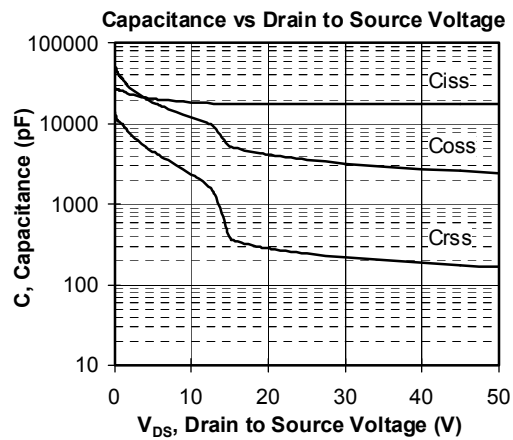
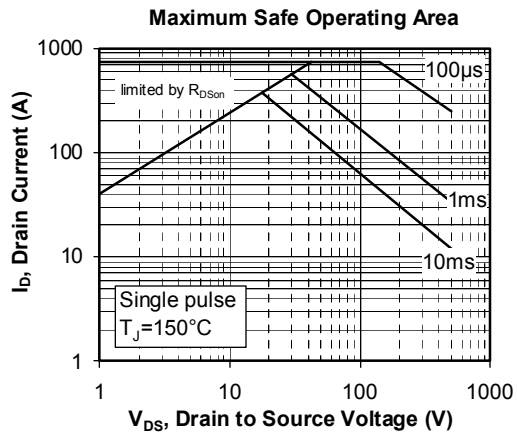
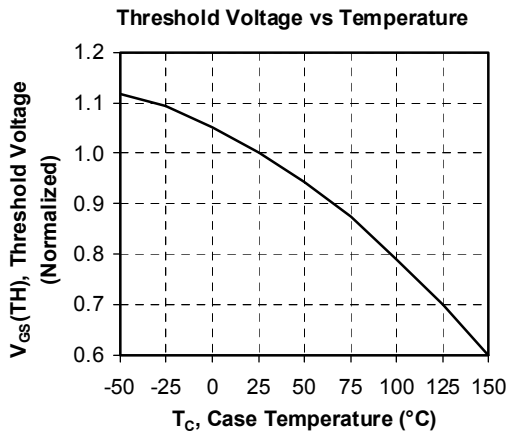
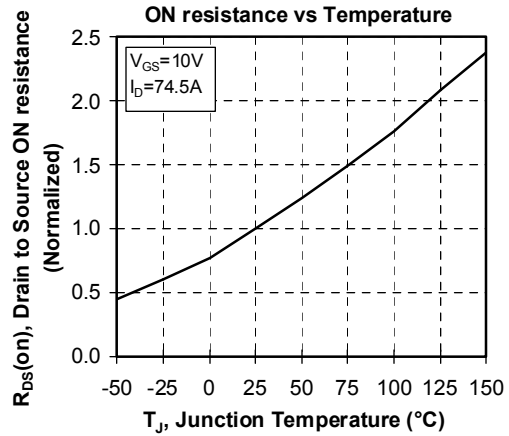
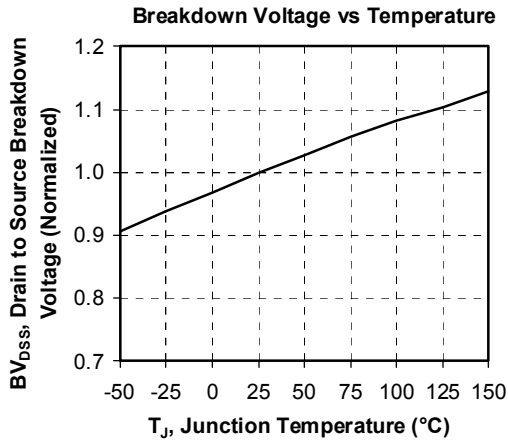


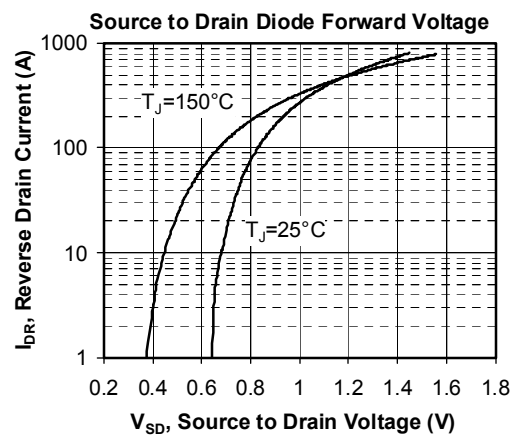
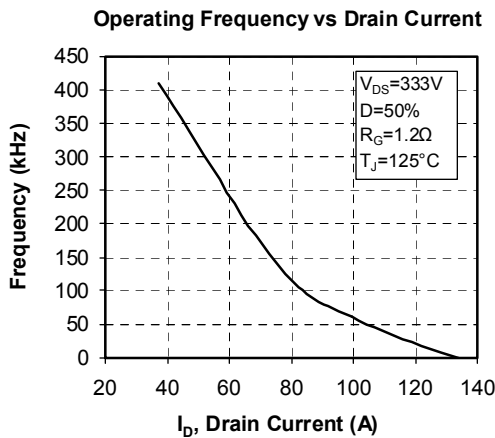
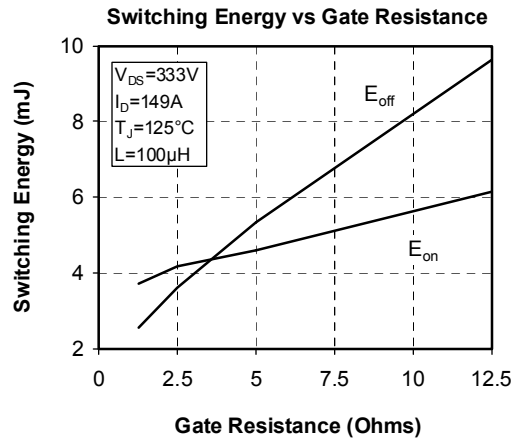
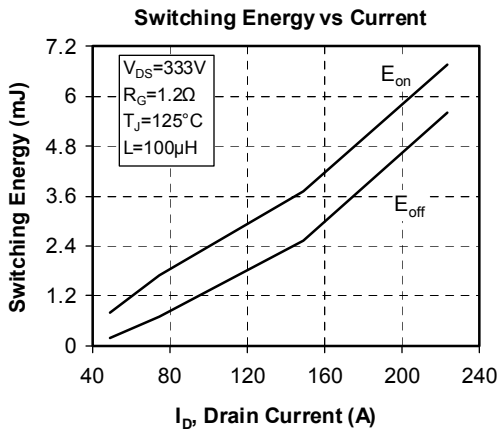
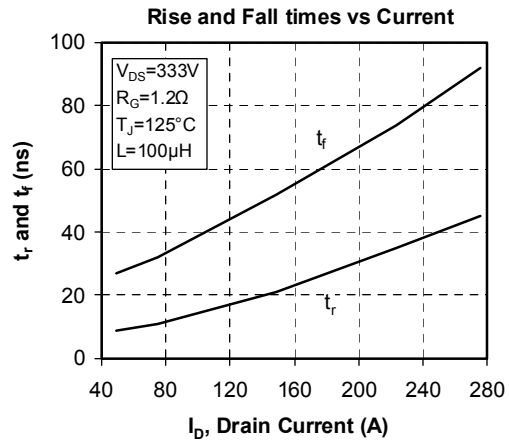
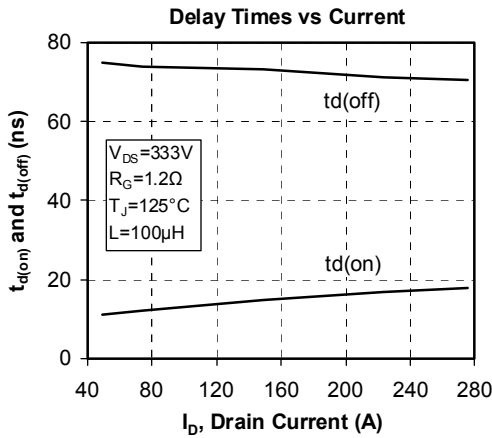
GENERAL TOLERANCES : +/-0.5mm

**Mounting holes: 4xØ6.5 mm**

**Typical Performance Curve**







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APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.